NSS20201MR6T1G

20 V, 3 A, Low V_{CE(sat)} **NPN Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	20	V
Collector-Base Voltage	V _{CBO}	40	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Collector Current – Continuous	I _C	2.0	Α
Collector Current - Peak	I _{CM}	3.0	Α

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C	P _D (Note 1)	460	mW
Derate above 25°C		3.7	mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 1)	272	°C/W
Total Device Dissipation T _A = 25°C	P _D (Note 2)	780	mW
Derate above 25°C		6.3	mW/°C
Thermal Resistance, Junction-to-Ambient	R _{θJA} (Note 2)	160	°C/W
Thermal Resistance, Junction-to-Lead #1	R _{θJL} (Note 1) R _{θJL} (Note 2)	48 40	°C/W
Total Device Dissipation (Single Pulse < 10 s)	P _{Dsingle} (Note 2)	1.5	W
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

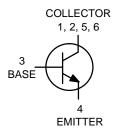
- FR-4 @ 100 mm2, 2 oz copper traces.
 FR-4 @ 500 mm2, 2 oz copper traces.



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20 VOLTS **3.0 AMPS** NPN LOW $V_{CE(sat)}$ TRANSISTOR EQUIVALENT $R_{DS(on)}$ 100 m Ω





CASE 318G TSOP-6 STYLE 6

DEVICE MARKING



VS0 = Specific Device Code

= Date Code = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NSS20201MR6T1G	TSOP-6 (Pb-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSS20201MR6T1G

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (I _C = 10 mA, I _B = 0)	V _{(BR)CEO}	20	_	-	V
Collector-Base Breakdown Voltage $(I_C = 0.1 \text{ mA}, I_E = 0)$	V _{(BR)CBO}	40	_	-	V
Emitter – Base Breakdown Voltage $(I_E = 0.1 \text{ mA}, I_C = 0)$	V _{(BR)EBO}	5.0	_	-	V
Collector Cutoff Current (V _{CB} = 40 V, I _E = 0)	Ісво	-	_	0.1	μΑ
Collector–Emitter Cutoff Current (V _{CES} = 20 V)	I _{CES}	-	_	0.1	μΑ
Emitter Cutoff Current (V _{EB} = 5.0 V)	I _{EBO}	-		0.1	μΑ
ON CHARACTERISTICS					
DC Current Gain (Note 3) (I _C = 1.0 mA, V _{CE} = 5.0 V) (I _C = 0.5 A, V _{CE} = 5.0 V) (I _C = 1.0 A, V _{CE} = 5.0 V)	h _{FE}	300 300 200	- - -	- - -	
Collector – Emitter Saturation Voltage (Note 3) ($I_C = 1.0 \text{ A}, I_B = 100 \text{ mA}$) ($I_C = 0.5 \text{ A}, I_B = 50 \text{ mA}$) ($I_C = 0.1 \text{ A}, I_B = 10 \text{ mA}$)	V _{CE(sat)}	- - -	- - -	0.150 0.100 0.025	V
Base – Emitter Saturation Voltage (Note 3) (I _C = 1.0 A, I _B = 0.1 A)	V _{BE(sat)}	-	-	0.95	V
Base – Emitter Turn–on Voltage (Note 3) (I _C = 1.0 A, V _{CE} = 2.0 V)	V _{BE(on)}	-	-	0.90	V
Cutoff Frequency ($I_C = 100 \text{ mA}$, $V_{CE} = 5.0 \text{ V}$, $f = 100 \text{ MHz}$	f _T	200	-	_	MHz
Output Capacitance (f = 1.0 MHz)	C _{obo}	_	_	15	pF

^{3.} Pulsed Condition: Pulse Width \leq 300 µsec, Duty Cycle \leq 2%.



TSOP-6 CASE 318G-02 **ISSUE V**

12

DATE 12 JUN 2012

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM
- LEAD THIORNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSIONS D
- AND E1 ARE DETERMINED AT DATUM H.
 PIN ONE INDICATOR MUST BE LOCATED IN THE INDICATED ZONE.

	MILLIMETERS		
DIM	MIN	NOM	MAX
Α	0.90	1.00	1.10
A1	0.01	0.06	0.10
b	0.25	0.38	0.50
С	0.10	0.18	0.26
D	2.90	3.00	3.10
E	2.50	2.75	3.00
E1	1.30	1.50	1.70
е	0.85	0.95	1.05
L	0.20	0.40	0.60
L2	0.25 BSC		
N.A	00		4.00

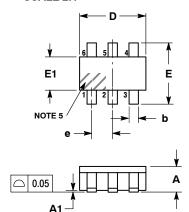
STYLE 5:

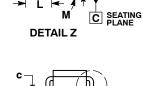
PIN 1. EMITTER 2

2. BASE 2 3. COLLECTOR 1 4. EMITTER 1

BASE 1

6. COLLECTOR 2





Н

c T	
DETAIL Z	

STYLE 1: PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN	STYLE PIN
STYLE 7: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. N/C	STYLI PIN

COLLECTOR

6. EMITTER

2. SOURCE 2

3. GATE 2

4. DRAIN 2

5. SOURCE 1

DRAIN 1

STYLE 13: PIN 1. GATE 1

1. EMITTER 2 2. BASE 1 3. 4. COLLECTOR 1 EMITTER 1 BASE 2 6. COLLECTOR 2

E 8: Vbus 2. D(in) 3. D(in)+ 4. D(out)+ 5. D(out) 6. GND

STYLE 14: PIN 1. ANODE SOURCE 3 GATE CATHODE/DRAIN CATHODE/DRAIN 5. CATHODE/DRAIN

2. N/C 3. R BOOST 4. Vz 5. V in 6. V out STYLE 9: PIN 1. LOW VOLTAGE GATE

STYLE 3:

PIN 1. ENABLE

2. DRAIN

3. SOURO

SOURCE

5. DRAIN 6. HIGH VOLTAGE GATE STYLE 15: PIN 1. ANODE SOURCE

3. GATE DRAIN 5. N/C 6. CATHODE STYLE 4: PIN 1. N/C 2. V in 3. NOT USED 4. GROUND 5. ENABLE 6. LOAD

STYLE 10 PIN 1. D(OUT)+ 2. GND 3. D(OUT)-4. D(IN)-

5. VBUS 6. D(IN)+ STYLE 16: PIN 1. ANODE/CATHODE

2. BASE

5. ANODE

3 FMITTER

COLLECTOR

CATHODE

PIN 1. SOURCE 1 2. DRAIN 2 DRAIN 2 4 SOURCE 2 5. GATE 1 6. DRAIN 1/GATE 2 STYLE 17: PIN 1. EMITTER

2. BASE

STYLE 11:

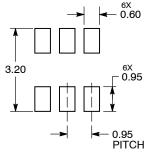
5. COLLECTOR 6. COLLECTOR STYLE 12: 2. GROUND

3. I/O 4. I/O 6. I/O

STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR

3 BASE 4. EMITTER

RECOMMENDED **SOLDERING FOOTPRINT***



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*

3 ANODE/CATHODE

CATHODE

COLLECTOR





XXX = Specific Device Code Α =Assembly Location

Υ = Year

W = Work Week = Pb-Free Package XXX = Specific Device Code M = Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot ' ", may or may not be present.

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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NTE15 NTE16001